## N-Channel Enhancement Mode MOSFET

## Features

- Surface-mounted package
- Halogen and Antimony Free(HAF), RoHS compliant

## Applications

- BLDC Motor drive applications
- Battery powered circuits
- Synchronous rectifier applications
- Resonant mode power supplies

#### **Key Parameters**

Parameter	Value	Unit	
BV <sub>DSS</sub>	100	V	
Proven Mox	115 @ V <sub>GS</sub> = 10 V	mΟ	
R <sub>DS(ON)</sub> Max	125 @ V <sub>GS</sub> = 4.5 V	11122	
V <sub>GS(th)</sub> typ	1.6	V	
Q <sub>g</sub> typ	20 @ V <sub>GS</sub> = 10 V	nC	

#### Absolute Maximum Ratings (at T<sub>a</sub> = 25°C unless otherwise specified)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V <sub>DS</sub>	100	V
Gate-Source Voltage	V <sub>GS</sub>	± 20	V
Lirgin ( Lirrant	= 25°C = 100°C	5 3.5	А
Peak Drain Current, Pulsed <sup>1)</sup>	I <sub>DM</sub>	20	А
Single-Pulse Avalanche Current	las	5	А
Single-Pulse Avalanche Energy 2)	Eas	3.7	mJ
Total Power Dissipation T <sub>c</sub>	= 25°C P <sub>tot</sub>	10	W
Operating Junction and Storage Temperature R	ange T <sub>j</sub> , T <sub>stg</sub>	- 55 to + 175	C°

Gate

Source

#### **Thermal Characteristics**

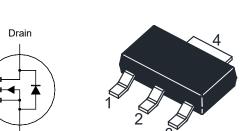
Parameter	Symbol	Max.	Unit
Thermal Resistance from Junction to Case	R <sub>θJC</sub>	15	°C/W
Thermal Resistance - Junction to Ambient <sup>3)</sup>	Reja	45	°C/W
Thermal Resistance - Junction to Ambient <sup>4)</sup> Steady State	$R_{\theta JA}$	100	°C/W

<sup>1)</sup> Pulse Test: Pulse Width  $\leq$  100 µs, Duty Cycle  $\leq$  2%, Repetitive rating, pulse width limited by junction temperature T<sub>J(MAX)</sub> = 175°C.

 $^{2)}$  Limited by  $T_{J(MAX)},$  starting  $T_{J}$  = 25°C, L = 0.3 mH,  $R_{g}$  = 25  $\Omega,$   $I_{AS}$  = 5 A,  $V_{GS}$  = 10 V.

 $^{3)}$  Device mounted on FR-4 substrate PC board, 2oz copper, with 1-inch square copper plate, t < 10 s.

<sup>4)</sup> Device mounted on FR-4 substrate PC board, minimum recommended footprint.



1.Gate 2.Drain 3.Source 4.Drain SOT-223 Plastic Package



# WTQ10N1K1LS-HAF

## Characteristics at $T_a = 25^{\circ}C$ unless otherwise specified

Parameter	Symbol	Min.	Тур.	Max.	Unit
STATIC PARAMETERS					
Drain-Source Breakdown Voltage at I <sub>D</sub> = 250 μA	BV <sub>DSS</sub>	100	-	-	V
Drain-Source Leakage Current at V <sub>DS</sub> = 80 V	IDSS	-	-	1	μA
Gate Leakage Current at $V_{GS}$ = ± 20 V	I <sub>GSS</sub>	-	-	± 100	nA
Gate-Source Threshold Voltage at V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250 μA	V <sub>GS(th)</sub>	1.2	-	2.5	V
Drain-Source On-State Resistance at $V_{GS}$ = 10 V, $I_D$ = 4 A at $V_{GS}$ = 4.5 V, $I_D$ = 3 A	R <sub>DS(on)</sub>	-	106 -	115 125	mΩ
DYNAMIC PARAMETERS					
Forward Transconductance at $V_{DS}$ = 5 V, $I_D$ = 4 A	<b>g</b> fs	-	8	-	S
Gate Resistance at $V_{DS} = 0 V$ , $V_{GS} = 0 V$ , f = 1 MHz	R <sub>g</sub>	-	1.1	-	Ω
Input Capacitance at V <sub>DS</sub> = 50 V, V <sub>GS</sub> = 0 V, f = 1 MHz	C <sub>iss</sub>	-	1155	-	pF
Output Capacitance at $V_{DS}$ = 50 V, $V_{GS}$ = 0 V, f = 1 MHz	Coss	-	28	-	pF
Reverse Transfer Capacitance at $V_{DS}$ = 50 V, $V_{GS}$ = 0 V, f = 1 MHz	C <sub>rss</sub>	-	25	-	pF
Gate Charge Total at $V_{DS} = 50 \text{ V}$ , $V_{GS} = 10 \text{ V}$ , $I_D = 4 \text{ A}$ at $V_{DS} = 50 \text{ V}$ , $V_{GS} = 4.5 \text{ V}$ , $I_D = 4 \text{ A}$	Qg	-	20 9	-	nC
Gate to Source Charge at $V_{DS}$ = 50 V, $V_{GS}$ = 10 V, $I_D$ = 4 A	Q <sub>gs</sub>	-	4	-	nC
Gate to Drain Charge at $V_{DS}$ = 50 V, $V_{GS}$ = 10 V, $I_D$ = 4 A	$Q_gd$	-	2	-	nC
Turn-On Delay Time at V <sub>DS</sub> = 50 V, V <sub>GS</sub> = 10 V, I <sub>D</sub> = 4 A, R <sub>g</sub> = 3.3 $\Omega$	t <sub>d(on)</sub>	-	14	-	ns
Turn-On Rise Time at V <sub>DS</sub> = 50 V, V <sub>GS</sub> = 10 V, I <sub>D</sub> = 4 A, R <sub>g</sub> = 3.3 $\Omega$	tr	-	4	-	ns
Turn-Off Delay Time at V <sub>DS</sub> = 50 V, V <sub>GS</sub> = 10 V, I <sub>D</sub> = 4 A, R <sub>g</sub> = 3.3 $\Omega$	$t_{d(off)}$	-	13	-	ns
Turn-Off Fall Time at V <sub>DS</sub> = 50 V, V <sub>GS</sub> = 10 V, I <sub>D</sub> = 4 A, R <sub>g</sub> = 3.3 $\Omega$	t <sub>f</sub>	-	2	-	ns
Body-Diode PARAMETERS					
Drain-Source Diode Forward Voltage at Is = 1 A, $V_{GS}$ = 0 V	V <sub>SD</sub>	-	-	1.2	V
Body-Diode Continuous Current	ls	-	-	5	Α
Body-Diode Continuous Current, Pulsed	lsм	-	-	20	Α
Body Diode Reverse Recovery Time at Is = 4 A, di/dt = 100 A / $\mu$ s	t <sub>rr</sub>	-	21	-	ns
Body Diode Reverse Recovery Charge at $I_s = 4 A$ , di/dt = 100 A / $\mu s$	Qrr	-	22	-	nC



## WTQ10N1K1LS-HAF

#### **Electrical Characteristics Curves**

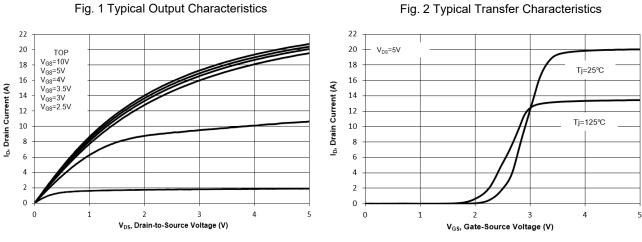
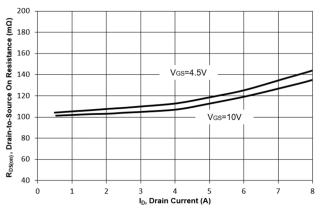


Fig. 3 on-Resistance vs Drain Current





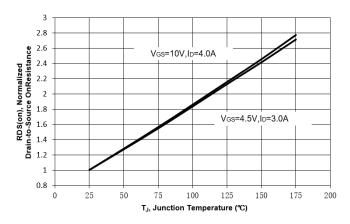
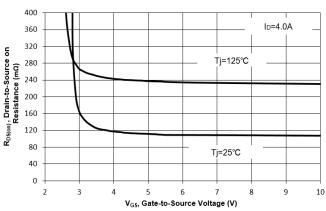


Fig. 4 on-Resistance vs. Gate to Source Voltage





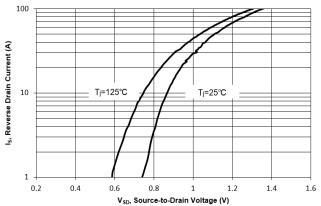




Fig. 2 Typical Transfer Characteristics

## **Electrical Characteristics Curves**

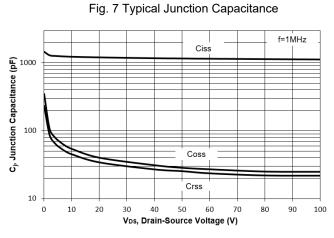
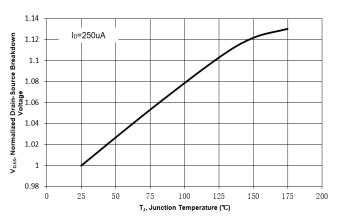
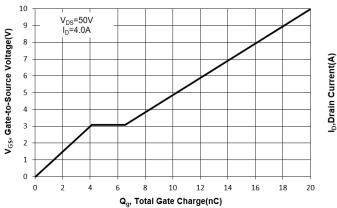


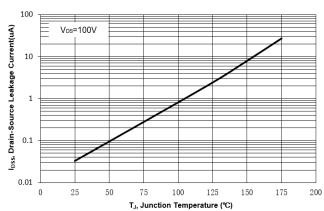
Fig. 9 V(BR)DSS vs. Junction Temperature

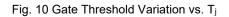


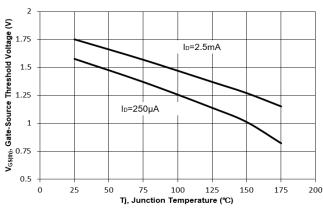


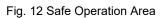


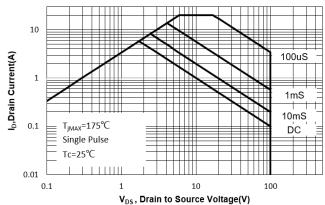














## **Electrical Characteristics Curves**

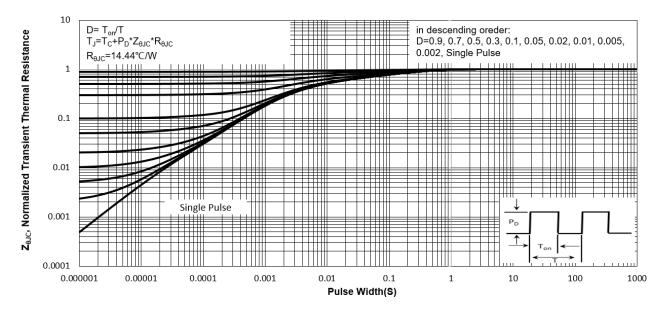
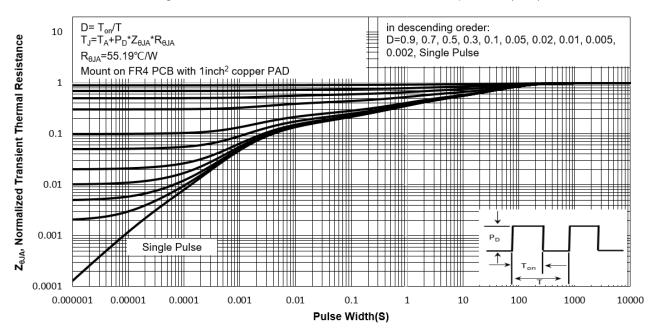




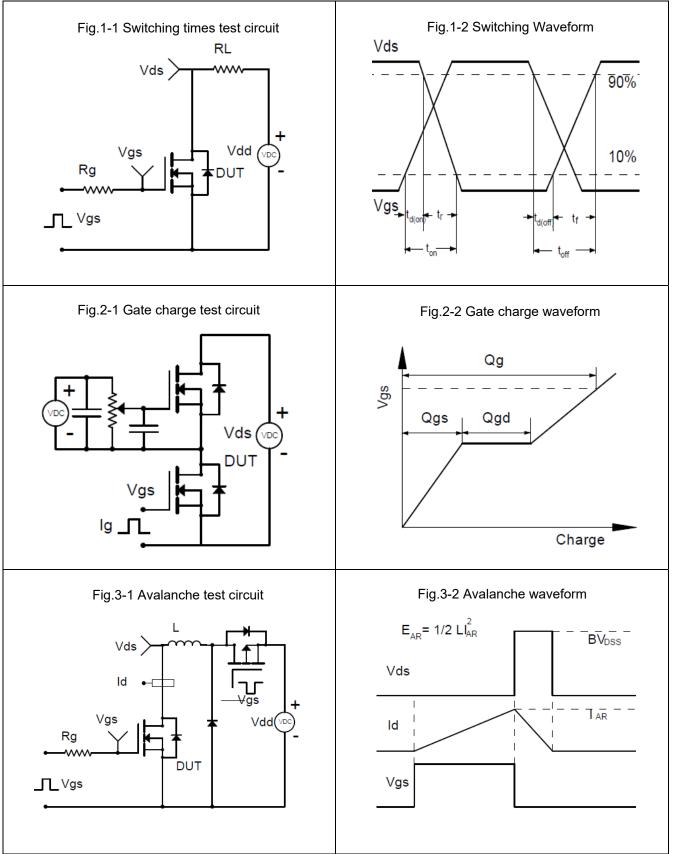
Fig. 14 Normalized Maximum Transient Thermal Impedance(ZeJA)





# WTQ10N1K1LS-HAF

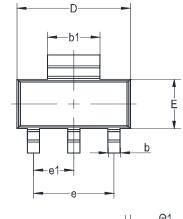
#### **Test Circuits**

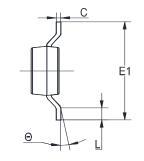


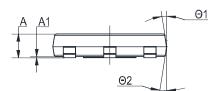


Dated: 10/01/2024 Rev: 03

## Package Outline (Dimensions in mm)

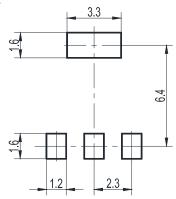






Unit	Α	A1	b	b1	С	D	E	E1	е	e1	L	Θ	Θ1	Θ2
mm	1.8	0.1	0.8	3.1	0.32	6.7	3.7	7.3	4.6	2.3	1.1	10°	7°	7°
mm	1.5	MAX	0.6	2.9	0.22	6.3	3.3	6.7	TYP	TYP	0.7	0°	0°	0°

## **Recommended Soldering Footprint**



#### **Packing information**

Dookogo	Tape Width	Pit	tch	Reel	Size	Per Peel Peeking Quantity
Package	(mm)	mm	inch	mm	inch	Per Reel Packing Quantity
SOT-223	12	8 ± 0.1	0.315 ± 0.004	330	13	3,000

## **Marking information**

- " TQ10N1K1LS " = Part No.
- " \*\*\*\*\*\* " = Date Code Marking

Font type: Arial

TQ10N1K1LS *****

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#### **SOT-223**